

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6176818

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
XINYU LI	06/10/2020
CHENGYI XIAO	06/29/2020
ZENGXIONG YANG	06/22/2020
QIHENG SONG	06/29/2020
RECEIVING PARTY DATA	
Name:	SZ DJI TECHNOLOGY CO., LTD.
Street Address:	NO. 18 GAOXIN SOUTH 4TH AVENUE, NANSHAN DISTRICT
Internal Address:	17/F WEST WING, SKYWORTH SEMICONDUCTOR DESIGN BLDG
City:	SHENZHEN
State/Country:	CHINA
Postal Code:	518057
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16915137
CORRESPONDENCE DATA	
Fax Number:	(703)935-1394
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	7034305759
Email:	uspto@anovallaw.com
Correspondent Name:	ANOVA LAW GROUP, PLLC
Address Line 1:	21495 RIDGETOP CIRCLE, SUITE 300
Address Line 4:	STERLING, VIRGINIA 20166
ATTORNEY DOCKET NUMBER:	00203.3417.00US
NAME OF SUBMITTER:	HOI CHEUNG
SIGNATURE:	/Hoi Cheung/
DATE SIGNED:	06/29/2020
Total Attachments: 5	
source=Assign002033417#page1.tif	

source=Assign002033417#page2.tif

source=Assign002033417#page3.tif

source=Assign002033417#page4.tif

source=Assign002033417#page5.tif

ASSIGNMENT

WHEREAS I/We, the below named inventor(s) (hereinafter referred to as Assignor(s)) have made an invention entitled:

VIDEO DATA PROCESSING METHOD, DEVICE, SYSTEM, AND STORAGE MEDIUM

for which I/We executed an application for United States Letters Patent herewith, as a national application in the United States of PCT Application No. PCT/CN2017/119751, or filed an application for United States Letters Patent on _____ (Application No. _____); and

WHEREAS, SZ DJI TECHNOLOGY CO., LTD., a limited company of P.R.China, whose post office address is 17/F West Wing Skyworth Semiconductor Design Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan District, Shenzhen, Guangdong, 518057, P.R. China (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in United States, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I/We, as Assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention, provisional Application No. _____, filed _____ (if any), and this application, and all divisions, substitutions, continuations, and continuations-in-part thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of the above provisional application (if any), as well as all rights to claim priority on the basis of this application, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and I/We hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys empowered in the Power of Attorney in this application, to insert here in parentheses (Application No. 16915137, filed June 29, 2020) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

Inventor 1:

Name: Xinyu LI
Address: 17/F West Wing Skyworth Semiconductor Design
Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan
District, Shenzhen, Guangdong 518057 P.R. China
Signature: XIN Yu Li
Date: 2020 / 6 / 10

Inventor 2:

Name: Chengyi XIAO
Address: 17/F West Wing Skyworth Semiconductor Design
Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan
District, Shenzhen, Guangdong 518057 P.R. China
Signature: _____
Date: _____

Inventor 3:

Name: Zengxiong YANG
Address: 17/F West Wing Skyworth Semiconductor Design
Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan
District, Shenzhen, Guangdong 518057 P.R. China
Signature: _____
Date: _____

IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

Inventor 1:

Name: Xinyu LI

Address: 17/F West Wing Skyworth Semiconductor Design
Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan
District, Shenzhen, Guangdong 518057 P.R. China

Signature: _____

Date: _____

Inventor 2:

Name: Chengyi XIAO

Address: 17/F West Wing Skyworth Semiconductor Design
Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan
District, Shenzhen, Guangdong 518057 P.R. China

Signature: Chengyi Xiao

Date: 2020.06.29

Inventor 3:

Name: Zengxiang YANG

Address: 17/F West Wing Skyworth Semiconductor Design
Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan
District, Shenzhen, Guangdong 518057 P.R. China

Signature: _____

Date: _____

IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

Inventor 1:

Name: Xinyu LI

Address: 17/F West Wing Skyworth Semiconductor Design
Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan
District, Shenzhen, Guangdong 518057 P.R. China

Signature:

Date:

Inventor 2:

Name: Chengyi XIAO

Address: 17/F West Wing Skyworth Semiconductor Design
Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan
District, Shenzhen, Guangdong 518057 P.R. China

Signature:

Date:

Inventor 3:

Name: Zengxiong YANG

Address: 17/F West Wing Skyworth Semiconductor Design
Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan
District, Shenzhen, Guangdong 518057 P.R. China

Signature: Zengxiong Yang

Date: 2020.06.22

Inventor 4:

Name: Qiheng SONG

Address: 17/F West Wing Skyworth Semiconductor Design
Bldg., No. 18 Gaoxin South 4th Avenue, Nanshan
District, Shenzhen, Guangdong 518057 P.R. China

Signature: Qiheng Song

Date: 2020 6 29